

Features

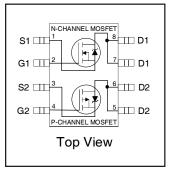
- Advanced Planar Technology
- Low On-Resistance
- Logic Level Gate Drive
- Dual N and P Channel MOSFET
- Surface Mount
- Available in Tape & Reel
- 150°C Operating Temperature
- Automotive [Q101] Qualified*
- · Lead-Free, RoHS Compliant

Description

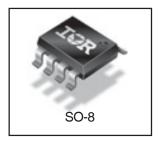
Specifically designed for Automotive applications, these HEXFET® Power MOSFET's in a Dual SO-8 package utilize the lastest processing techniques to achieve extremely low onresistance per silicon area. Additional features of these Automotive qualified HEXFET Power MOSFET's are a 150°C junction operating temperature, fast switching speed and improved repetitive avalanche rating. These benefits combine to make this design an extremely efficient and reliable device for use in Automotive applications and a wide variety of other applications.

The efficient SO-8 package provides enhanced thermal characteristics and dual MOSFET die capability making it ideal in a variety of power applications. This dual, surface mount SO-8 can dramatically reduce board space and is also available in Tape & Reel.

HEXFET® Power MOSFET



	N-Ch	P-Ch			
V _{(BR)DSS}	30V	-30V			
R _{DS(on)} typ.	0.038Ω	0.070Ω			
max.	0.045Ω	0.090Ω			
I _D	5.8A	-4.3A			



G	D	S
Gate	Drain	Source

Page Part Number	Deelsege Type	Standard Page 1	ack	Ovdeveble Post Number
Base Part Number	Package Type	Form	Quantity	Orderable Part Number
ALUDEZOZOO	00.0	Tube	95	AUIRF7379Q
AUIRF7379Q	SO-8	Tape and Reel	4000	AUIRF7379QTR

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

	Parameter	Max	x.	Units
	Faranietei	N-Channel	P-Channel	
V_{DS}	Drain-Source Voltage	30	-30	V
I _D @ T _A = 25°C	Continuous Drain Current, V _{GS} @ 10V	5.8	-4.3	
I _D @ T _A = 70°C	Continuous Drain Current, V _{GS} @ 10V	4.6	-3.4	Α
I _{DM}	Pulsed Drain Current ①	46	46 -34	
P _D @T _A = 25°C	Power Dissipation	2.5	2.5	
	Linear Derating Factor	0.0	0.02	
V_{GS}	Gate-to-Source Voltage	± 2	± 20	
dv/dt	Peak Diode Recovery dv/dt ②	5.0	-5.0	V/ns
T_J	Operating Junction and	.55 to	. 150	°C
T _{STG}	Storage Temperature Range	-55 to	-55 to + 150	

Thermal Resistance

	Parameter	Тур.	Max.	Units
$R_{\theta JA}$	Junction-to-Ambient @		50	°C/W

Submit Datasheet Feedback

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^{*}Qualification standards can be found at http://www.irf.com/



Static Electrical Characteristics @ $T_J = 25$ °C (unless otherwise stated)

	Parameter		Min.	Тур.	Max.	Units	Conditions
V	Drain to Cauraa Braakdaum Valtaga	N-Ch	30			V	$V_{GS} = 0V, I_D = 250\mu A$
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	P-Ch	-30			, v	$V_{GS} = 0V, I_D = -250\mu A$
AV /AT	Brookdown Voltage Town Coefficient	N-Ch		0.032		V/°C	Reference to 25°C, I _D = 1mA
$\Delta V_{(BR)DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient	P-Ch		-0.037		V/ C	Reference to 25°C, I _D = -1mA
		N-Ch		0.038	0.045		V _{GS} = 10V, I _D = 5.8A ③
B	Static Drain-to-Source On-Resistance	IN-CII		0.055	0.075	Ω	$V_{GS} = 4.5V, I_D = 4.9A$ ③
R _{DS(on)}	Static Diatif-to-Source Off-nesistance	P-Ch		0.070	0.090	1 12	V _{GS} = -10V, I _D = -4.3A ③
		P-CII		0.130	0.180		$V_{GS} = -4.5V, I_{D} = -3.7A$ ③
V	Outs Three hold Walters	N-Ch	1.0		3.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
$V_{GS(th)}$	Gate Threshold Voltage	P-Ch	-1.0		-3.0	ľ	$V_{DS} = V_{GS}$, $I_D = -250\mu A$
afo	Forward Transconductance	N-Ch	5.2			S	$V_{DS} = 15V, I_D = 2.4A$ ③
gfs	Forward Transconductance	P-Ch	2.5			٦	$V_{DS} = -24V, I_{D} = -1.8A$ ③
		N-Ch			1.0		$V_{DS} = 24V$, $V_{GS} = 0V$
	Drain to Cauran Lankaga Current	P-Ch			-1.0		$V_{DS} = -24V$, $V_{GS} = 0V$
I _{DSS}	Drain-to-Source Leakage Current	N-Ch			25	μA	$V_{DS} = 24V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
		P-Ch			-25		$V_{DS} = -24V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage				± 100	nA	$V_{GS} = \pm 20V$

Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated)

	Parameter		Min.	Тур.	Max.	Units	Conditions
^	Total Cata Charge	N-Ch			25		N-Channel
Q_g	Total Gate Charge	P-Ch			25	Ī	$I_D = 2.4A V_{DS} = 24V, V_{GS} = 10V$
0	Gate-to-Source Charge	N-Ch			2.9	nC	
Q _{gs}	Gate-to-Source Charge	P-Ch			2.9		P-Channel 3
Q_{gd}	Gate-to-Drain ("Miller") Charge	N-Ch			7.9		$I_D = -1.8A V_{DS} = -24V, V_{GS} = -10V$
⊶ga	date to Brain (Willer) Onlarge	P-Ch			9.0		
t., .	Turn-On Delay Time	N-Ch		6.8			N-Channel
t _{d(on)}	Turr-On Belay Time	P-Ch		11			$V_{DD} = 15V$, $ID=2.4A$, $RG = 6.0\Omega$
t.	Rise Time	N-Ch		21			$R_D = 6.2\Omega$
٩	The Time	P-Ch		17		ns	P-Channel 3
t ,, ,,	Turn-Off Delay Time	N-Ch		22		113	$V_{DD} = -15V$, ID=-1.8A, RG = 6.0Ω
t _{d(off)}	Tuni-On Belay Time	P-Ch		25			$R_D = 8.2\Omega$
ŧ.	Fall Time	N-Ch		7.7			
ч	i all tille	P-Ch		18			
L _D	Internal Drain Inductance	N-P		4.0		nH	Between lead, 6mm (0.25in.) from package
L _S	Internal Source Inductance	N-P		6.0		1111	and center of die contact
C _{iss}	Input Capacitance	N-Ch		520			N-Channel
Oiss	при Сараспансе	P-Ch		440			$VGS = 0V, V_{DS} = 25V, f = 1.0Mhz$
C _{oss}	Output Capacitance	N-Ch		180		pF	
OSS	Опри Оараскансе	P-Ch		200		Pi	P-Channel
C _{rss}	Reverse Transfer Capacitance	N-Ch		72			$VGS = 0V, V_{DS} = -25V, f = 1.0Mhz$
Orss	Tieverse Transfer Capacitance	P-Ch	l —	93			

Diode Characteristics

	Parameter		Min.	Тур.	Max.	Units	Conditions
IS	Continuous Source Current	N-Ch			3.1		
	(Body Diode)	P-Ch			-3.1	Α	
I _{SM}	Pulsed Source Current	N-Ch			46	_ ^	
	(Body Diode) ①	P-Ch			-34		
V	Diode Forward Voltage	N-Ch			1.0	V	$T_J = 25^{\circ}\text{C}, I_S = 1.8\text{A}, V_{GS} = 0\text{V}$ $T_J = 25^{\circ}\text{C}, I_S = -1.8\text{A}, V_{GS} = 0\text{V}$
V_{SD}	Diode i orward voltage	P-Ch			-1.0	7 V	$T_J = 25^{\circ}C$, $I_S = -1.8A$, $V_{GS} = 0V$ ⁽³⁾
+	Reverse Recovery Time	N-Ch		47	71	ns	N-Channel
۲rr	neverse necovery Time	P-Ch		53	80	115	T _J = 25°C, I _F = 2.4A di/dt = 100A/µs
0	Payaraa Pagayary Chargo	N-Ch		56	84	nC	P-Channel 3
Q _{rr}	Reverse Recovery Charge	P-Ch		66	99	IIC	T _J = 25°C, I _F = -1.8A di/dt = 100A/µs

Notes ① through ④ are on page 10

N-Channel

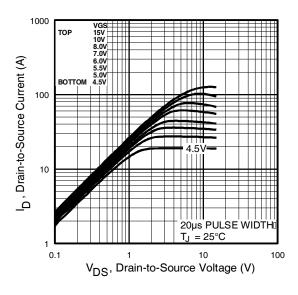


Fig 1. Typical Output Characteristics

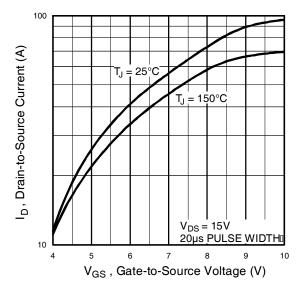


Fig 3. Typical Transfer Characteristics

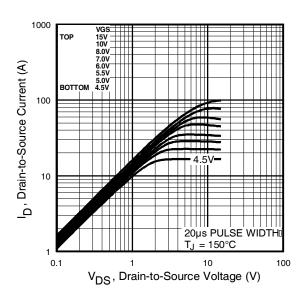


Fig 2. Typical Output Characteristics

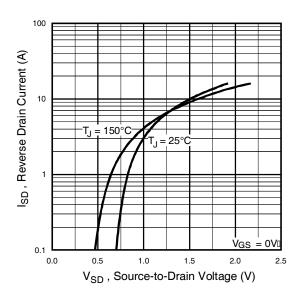
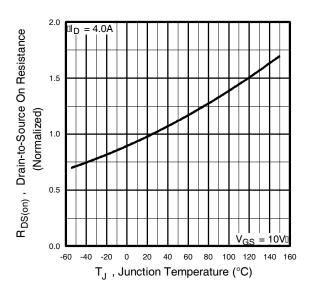


Fig 4. Typical Source-Drain Diode Forward Voltage





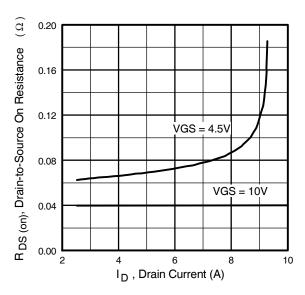


Fig 5. Normalized On-Resistance Vs. Temperature

Fig 6. Typical On-Resistance Vs. Drain Current

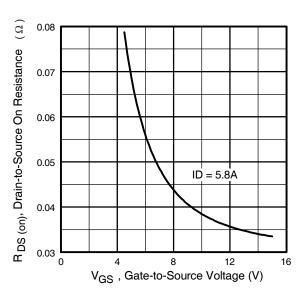


Fig 7. Typical On-Resistance Vs. Gate Voltage



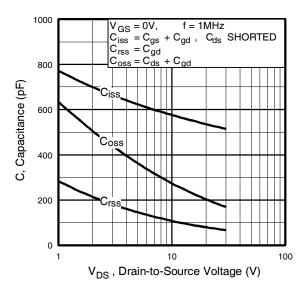


Fig 8. Typical Capacitance Vs. Drain-to-Source Voltage

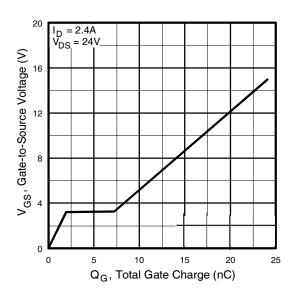


Fig 9. Typical Gate Charge Vs. Gate-to-Source Voltage

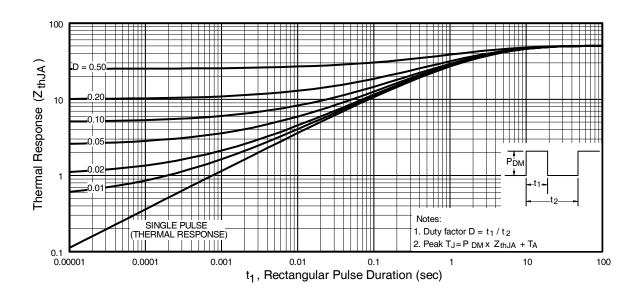
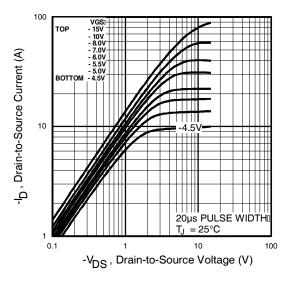


Fig 10. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



P-Channel



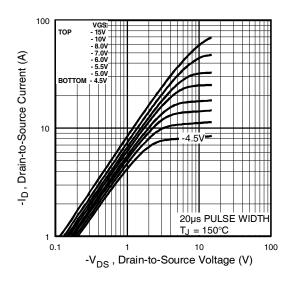
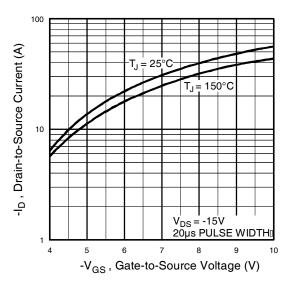


Fig 11. Typical Output Characteristics

Fig 12. Typical Output Characteristics



(V) tueur T_J = 150°C T_J = 25°C T_J = 0.1 0.0 0.3 0.6 0.9 1.2 1.5 -V_{SD} , Source-to-Drain Voltage (V)

Fig 13. Typical Transfer Characteristics

Fig 14. Typical Source-Drain Diode Forward Voltage



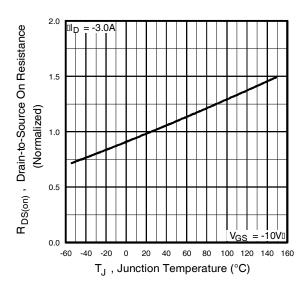


Fig 15. Normalized On-Resistance Vs. Temperature

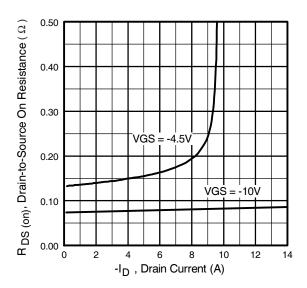


Fig 16. Typical On-Resistance Vs. Drain Current

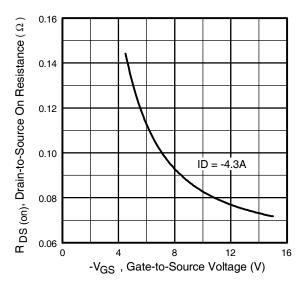
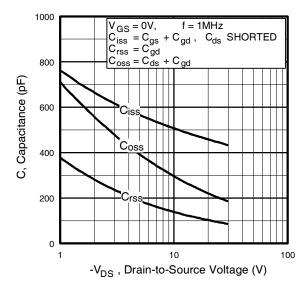


Fig 17. Typical On-Resistance Vs. Gate Voltage



P-Channel



(A) abation of the state of the

Fig 18. Typical Capacitance Vs. Drain-to-Source Voltage

Fig 19. Typical Gate Charge Vs. Gate-to-Source Voltage

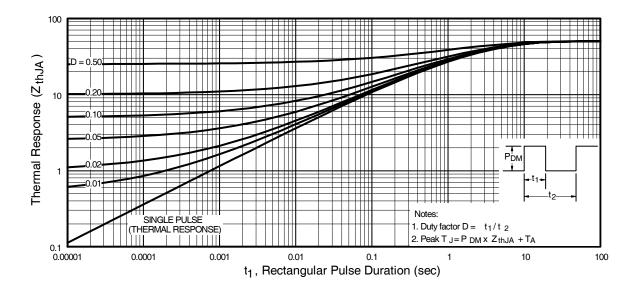
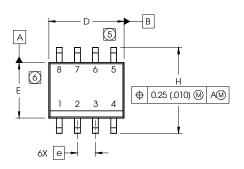


Fig 20. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

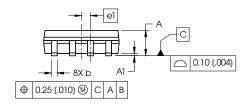


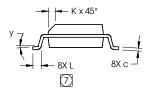
SO-8 Package Outline

Dimensions are shown in millimeters (inches)



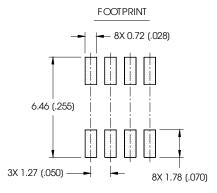
DIM	INC	HES	MILLIM	ETERS
DIIVI	MIN	MAX	MIN	MAX
Α	.0532	.0688	1.35	1.75
A1	.0040	.0098	0.10	0.25
b	.013	.020	0.33	0.51
С	.0075	.0098	0.19	0.25
D	.189	.1968	4.80	5.00
Е	.1497	.1574	3.80	4.00
е	.050 B	ASIC	1.27 B	ASIC
еl	.025 B	ASIC	0.635 E	BASIC
Н	.2284	.2440	5.80	6.20
K	.0099	.0196	0.25	0.50
L	.016	.050	0.40	1.27
У	0°	8°	0°	8°



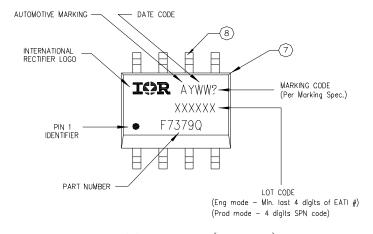


NOTES:

- 1. DIMENSIONING & TOLERANGING PER ASME Y14.5M-1994.
- 2. CONTROLLING DIMENSION: MILLIMETER
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
- 4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
- (5) DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.15 (.006).
- (6) DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 (.010).
- (7) DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.



SO-8 Part Marking



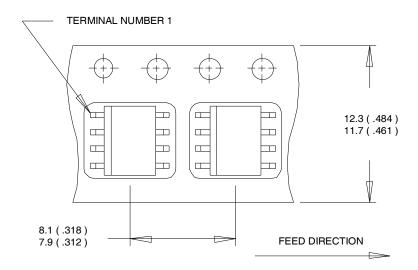
TOP MARKING (LASER)

Note: For the most current drawing please refer to IR website at http://www.irf.com/package/



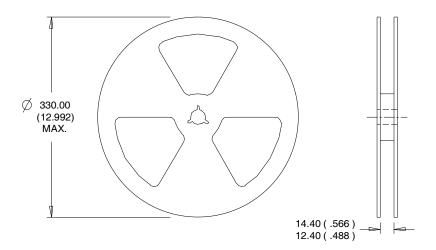
SO-8 Tape and Reel

Dimensions are shown in millimeters (inches)



NOTES:

- 1. CONTROLLING DIMENSION: MILLIMETER.
- 2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
- 3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES:

- 1. CONTROLLING DIMENSION : MILLIMETER.
- 2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- $\begin{tabular}{l} \hline \& N-Channel $I_{SD} \le 2.4A$, $di/dt \le 73A/\mu s$, $V_{DD} \le V_{(BR)DSS}$, $T_J \le 150^{\circ}C$ \\ P-Channel $I_{SD} \le -1.8A$, $di/dt \le 90A/\mu s$, $V_{DD} \le V_{(BR)DSS}$, $T_J \le 150^{\circ}C$ \\ \hline \end{tabular}$



Qualification Information[†]

		Automotive (per AEC-Q101) ††				
		(per AEC-	Q101) ''			
Qualification	ı Level	Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.				
Moisture Sensitivity Level		SO-8	MSL1			
	Machine Model	N Ch: Class M2(+/- 150V) ^{†††} P Ch: Class M2(+/- 150V) ^{†††} (per AEC-Q101-002)				
ESD	Human Body Model	N Ch : Class H1A(+/- 500V) ^{†††} (per AEC-C	P Ch: Class H0(+/- 250V) ^{†††}			
Charged Device Model		N Ch: Class C5(+/- 2000V) ^{†††} P Ch: Class C5(+/- 2000V) (per AEC-Q101-005)				
RoHS Compliant Yes			s			

- † Qualification standards can be found at International Rectifier's web site: http://www.irf.com/
- †† Exceptions (if any) to AEC-Q101 requirements are noted in the qualification report.
- ††† Highest passing voltage



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For technical support, please contact IR's Technical Assistance Center http://www.irf.com/technical-info/

WORLDHEADQUARTERS:

101 N. Sepulveda Blvd., El Segundo, California 90245 Tel: (310) 252-7105



Revision History

Date	Comments
3/10/2014	Added "Logic Level Gate Drive" bullet in the features section on page 1
0/10/2014	Indated data sheet with new IR cornorate template

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